



UL 60079-18

STANDARD FOR SAFETY

Explosive Atmospheres – Part 18: Equipment
Protection by Encapsulation “m”

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UL Standard for Safety for Explosive Atmospheres – Part 18: Equipment Protection by Encapsulation “m”,
UL 60079-18

Fourth Edition, Dated December 14, 2015

Summary of Topics

The revision to UL 60079-18 dated February 7, 2019, is being issued to incorporate the following changes:

Correction to the Cable Pull Test Procedure in 8.2.5.1

Please note that the national difference document incorporates all of the US National Differences for UL 60079-18 based on IEC 60079-18, Explosive Atmospheres – Part 18: Equipment Protection by Encapsulation “m”, (fourth edition issued December 2014).

Text that has been changed in any manner or impacted by UL’s electronic publishing system is marked with a vertical line in the margin.

The requirements are substantially in accordance with Proposal(s) on this subject dated December 7, 2018.

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ANSI/UL 60079-18-2019

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UL 60079-18

**Standard for Explosive Atmospheres - Part 18: Equipment Protection by
Encapsulation "m"**

Fourth Edition

December 14, 2015

This ANSI/UL Standard for Safety consists of the Fourth Edition, including revisions through February 7, 2019.

The most recent designation of ANSI/UL 60079-18 as an American National Standard (ANSI) occurred on February 7, 2019. ANSI approval for a standard does not include the Cover Page, Transmittal Pages, Title Page, or Preface. The National Difference Page and IEC Foreword are also excluded from the ANSI approval of IEC-based standards. Any other portions of this ANSI/UL standard that were not processed in accordance with ANSI/UL requirements are noted at the beginning of the impacted sections.

Comments or proposals for revisions on any part of the Standard may be submitted to UL at any time. Proposals should be submitted via a Proposal Request in UL's On-Line Collaborative Standards Development System (CSDS) at <https://csds.ul.com>.

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PREFACE

This harmonized standard is based on IEC Publication 60079-18: Edition 4 issued December, 2014, Explosive Atmospheres - Part 18: Equipment Protection by Encapsulation "m" as revised by Amendment Edition 4.1 issued August, 2017. IEC publication 60079-18 is copyrighted by the IEC.

This standard is considered suitable for use for conformity assessment within the stated scope of the standard.

This standard has been approved by the American National Standards Institute (ANSI) as an American National Standard.

Application of Standard

Where reference is made to a specific number of samples to be tested, the specified number is to be considered a minimum quantity.

Note: Although the intended primary application of this standard is stated in its scope, it is important to note that it remains the responsibility of the users of the standard to judge its suitability for their particular purpose.

Level of Harmonization

This standard adopts the IEC text with national differences.

All national differences from the IEC text are included in the UL version of the standard. While the technical content is the same in UL's version, the format and presentation may differ.

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There are five types of National Differences as noted below. The difference type is noted on the first line of the National Difference in the standard. The standard may not include all types of these National Differences.

The UL printed standard includes the national difference types within the body of the text.

D1 – These are National Differences which are based on **basic safety principles and requirements**, elimination of which would compromise safety for consumers and users of products.

D2 – These are National Differences based on **safety practices**. These are differences for IEC requirements that may be acceptable, but adopting the IEC requirements would require considerable retesting or redesign on the manufacturer’s part.

DC – These are National Differences based on the **component standards** and will not be deleted until a particular component standard is harmonized with the IEC component standard.

DE – These are National Differences based on **editorial comments or corrections**.

DR – These are National Differences based on the **national regulatory requirements**.

Each national difference contains a description of what the national difference entails. Typically one of the following words is used to explain how the text of the national difference is to be applied to the base IEC text:

Addition / Add - An addition entails adding a complete new numbered clause, subclause, table, figure, or annex. Addition is not meant to include adding select words to the base IEC text.

Deletion / Delete - A deletion entails complete deletion of an entire numbered clause, subclause, table, figure, or annex without any replacement text.

Modification / Modify - A modification is an altering of the existing base IEC text such as the addition, replacement or deletion of certain words or the replacement of an entire clause, subclause, table, figure, or annex of the base IEC text.

INTERNATIONAL ELECTROTECHNICAL COMMISSION

EXPLOSIVE ATMOSPHERES – Part 18: Equipment protection by encapsulation “m”

FOREWORD

1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as “IEC Publication(s)”). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.

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Standard IEC 60079-18 has been prepared by IEC technical committee 31: Equipment for explosive atmospheres.

This fourth edition cancels and replaces the third edition of IEC 60079-18 (2009), and constitutes a technical revision.

This International Standard is to be used in conjunction with IEC 60079-0, *Explosive atmospheres – Part 0: Equipment – General requirements*.

This edition includes the following significant technical changes with respect to the previous edition:

Explanation of the significance of the changes	Clause	Type		
		Minor and editorial changes	Extension	Major technical changes
Definitions deleted and moved to IEC 60079-0	3	X		
Heading modified /added to clarify which requirements are additional requirements for “ma” level of protection only	4	X		
Thermal conductivity added	5.2		X	
Note added that it is not a requirement of this standard that conformity to the manufacturer’s specification of the compound needs to be verified	5.3.2	X		
Clarification added	6.2.2	X		
Clarification added	7.1	X		
For the determination of the faults options added and clarification given	7.2		X	
Additional information included in Figure 1	7.4.1	X		
“Varnish and similar coatings are not considered to be solid insulation.” was added in this section and deleted in the definition on 3.8	7.4.2	X		
For rigid, multi-layer printed wiring boards with through connections additional standards added	7.4.3.1		X	
Protection against inadmissible temperatures and damage to the cells	7.8.3			C1
Electrical protective devices clarified and additional possibilities added	7.9.2		X	
Thermal protective devices clarified and additional possibilities added	7.9.3		X	
2/3 voltage limitation deleted	7.9.3		X	
Determination of the maximum temperature for “Da” fixed	8.2.2			C2
Stabilization of the temperature	8.2.2			C3
Thermal endurance to heat	8.2.3.1		X	
Temperature fixed as referenced service temperatures and tests given as alternatives	8.2.3.1.1		X	
For the dielectric strength test procedure alternative possibilities added	8.2.4.1		X	
Alternative test methods for the required pressure test for Group I and Group II electrical equipment added	8.2.6		X	
Sealing test for built-in protective devices	8.2.8		X	
For the dielectric strength test procedure alternative possibilities added	9.2		X	
Marking	10	X	X	

Explanation of the Types of Significant Changes:

A) Definitions

1. Minor and editorial changes:

- Clarification
- Decrease of technical requirements
- Minor technical change
- Editorial corrections

These are changes which modify requirements in an editorial or a minor technical way. They include changes of the wording to clarify technical requirements without any technical change, or a reduction in level of existing requirement.

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2. Extension:

These are changes which add new or modify existing technical requirements, in a way that new options are given, but without increasing requirements for equipment that was fully compliant with the previous standard. Therefore, these will not have to be considered for products in conformity with the preceding edition.

3. Major technical changes:

- Addition of technical options
- addition of technical requirements
- increase of technical requirements

These are changes to technical requirements (addition, increase of the level or removal) made in a way that a product in conformity with the preceding edition will not always be able to fulfil the requirements given in the later edition. These changes have to be considered for products in conformity with the preceding edition. For these changes additional information is provided in item B) below.

Note These changes represent current technological knowledge. However, these changes should not normally have an influence on equipment already placed on the market.

B) Information about the background of 'Major technical changes'

C1 Clause 7.8.3 modified and additional requirements added for cells or batteries

C2 The flexibility given in IEC 60079-0 is replaced by a min. requirement. For level of protection "ma" equipment, designed for EPL "Da" the maximum surface temperature shall be determined with the equipment mounted in accordance with the manufacturer's instructions, and surrounded on all available surfaces by dust with a layer thickness of at least 200 mm

C3 The increase of the temperature during the test can be a very slow process. The final temperature shall be considered to have been reached when the rate of rise of temperature does not exceed 1 K/24 h

The text of this standard is based on the following documents:

FDIS	Report on voting
31/1152/FDIS	31/1168/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The list of all parts of IEC 60079 series, published under the general title *Explosive atmospheres*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

IMPORTANT – The "colour inside" logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this publication using a colour printer.

EXPLOSIVE ATMOSPHERES – Part 18: Equipment protection by encapsulation “m”

1 Scope

1DV DR Modification of Clause 1 to replace with the following:

This part of IEC 60079 standard gives the specific requirements for the construction, testing and marking of electrical equipment, parts of electrical equipment and Ex components with the type of protection encapsulation “m” intended for use in explosive gas atmospheres or explosive dust atmospheres.

This part standard applies only for encapsulated electrical equipment, encapsulated parts of electrical equipment and encapsulated Ex components (hereinafter always referred to as “m” equipment) where the rated voltage does not exceed 11 kV.

The application of electrical equipment in atmospheres, which may contain explosive gas as well as combustible dust simultaneously, may require additional protective measures.

This standard does not apply to dusts of explosives, which do not require atmospheric oxygen for combustion, or to pyrophoric substances.

This standard does not take account of any risk due to an emission of flammable or toxic gas from the dust.

This standard supplements and modifies the general requirements of IEC 60079-0. Where a requirement of this standard conflicts with a requirement of IEC 60079-0, the requirement of this standard takes precedence.

Where references are made to other IEC 60079 standards, the referenced requirements found in these standards shall apply as modified by any applicable U.S. National Differences.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

2DV DR Modification of Clause 2 references to replace with the following:

ASTM-11, Specification for Wire Cloth and Sieves for Testing Purposes

IEC 60079-0, Explosive atmospheres — Part 0: Equipment — General requirements

IEC 60079-7, Explosive atmospheres — Part 7: Equipment protection by increased safety “e”

IEC 60079-11, Explosive atmospheres — Part 11: Equipment protection by intrinsic safety “i”

IEC 60079-15, Explosive atmospheres — Part 15: Equipment protection by type of protection “n”

~~IEC 60079-26, Explosive atmospheres — Part 26: Equipment with equipment protection level (EPL) Ga~~

~~IEC 60079-31, Explosive atmospheres — Part 31: Equipment dust ignition protection by enclosures "t"~~

IEC 60127 (all parts), Miniature fuses

IEC 60243-1, Electrical strength of insulating materials – Test methods – Part 1: Tests at power frequencies

~~IEC 60691, Thermal links — Requirements and application guide~~

~~IEC 60730-2-9, Automatic electrical controls for household and similar use — Part 2-9: Particular requirements for temperature sensing controls~~

IEC 60738-1, Thermistors – Directly heated positive temperature coefficient – Part 1: Generic specification

IEC 61140, Protection against electric shock – Common aspects for installation and equipment

IEC 61558-1, Safety of power transformers, power supplies, reactors, and similar products – Part 1: General requirements and tests

IEC 61558-2-6, Safety of transformers, reactors, power supply units and similar products for supply voltages up to 1 100 V – Part 2-6: Particular requirements and tests for safety isolating transformers and power supply units incorporating safety isolating transformers

IEC 62326-4-1, Printed boards – Part 4: Rigid multilayer printed boards with interlayer connections – Sectional specification – Section 1: Capability detail specification – Performance levels A, B and C

IPC-A-600, Acceptability of Printed Boards

IPC-6012, Qualification and Performance Specification for Rigid Printed Boards

ISA 60079-26, Explosive atmospheres – Part 26: Equipment for Use in Class 1, Zone 0 Hazardous (Classified) Locations

ISA 60079-31, Explosive atmospheres – Part 31: Equipment Dust Ignition Protection by Enclosure "t"

ANSI/UL 248 (all parts), Standard for low-voltage fuses

ANSI/UL 746B, Standard for polymeric materials – Long term property evaluations

ANSI/UL 796, Printed-Wiring Boards

UL 60079-0 Explosive Atmospheres Part 0: Equipment – General Requirements

UL 60079-7 Explosive Atmospheres – Part 7: Equipment Protection by Increased Safety "e"

UL 60079-11 Explosive Atmospheres – Part 11: Equipment Protection by Intrinsic Safety "i"

UL 60079-15 Explosive Atmospheres – Part 15: Equipment Protection by Type of Protection “n”

UL 60691, Thermal-links – Requirements and application guide

UL 60730-2-9, Automatic electrical controls for household and similar use – Part 2-9: Particular requirements for temperature sensing controls

3 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 60079-0 and the following definitions apply.

NOTE Additional definitions applicable to explosive atmospheres can be found in IEC 60050-426.

3.1 **encapsulation “m”** type of protection whereby parts that are capable of igniting an explosive atmosphere by either sparking or heating are fully enclosed in a compound or other non-metallic enclosure with adhesion in such a way as to avoid ignition of a dust layer or explosive atmosphere under operating or installation conditions

3.2 **temperature range of the compound** range of temperatures within which the properties of the compound, in either operation or storage, permit compliance with the requirements of IEC 60079-18

3.3 **free surface** compound surface exposed to the explosive atmospheres and/or dust layers

3.4 **switching contact** mechanical contact, which makes and breaks an electrical circuit

3.5 **adhesion** moisture, gas and dust tight permanent bonding of a compound to a surface

3.6 **countable fault** fault which occurs in parts of electrical equipment conforming to the constructional requirements

3.7 **infallible separation** separation between electrically conductive parts that is considered as not subject to short circuits

3.8 **solid insulation** insulation material which is extruded or moulded, but not poured

Note 1 to entry: Insulators fabricated from two or more pieces of electrical insulating material, which are solidly bonded together may be considered as solid.

4 General

4.1 Level of protection (equipment protection level (EPL))

Electrical equipment with encapsulation “m” shall be either:

- a) level of protection “ma” (EPL “Ma, Ga, Da”),
- b) level of protection “mb” (EPL “Mb, Gb, Db”), or
- c) level of protection “mc” (EPL “Gc, Dc”).

The requirements of this standard apply to all levels of protection for encapsulation “m” unless otherwise stated.

4.2 Additional requirements for level of protection “ma” and “mb”

Components without additional protection shall be used only if they cannot damage the encapsulation mechanically or thermally in the case of any fault conditions specified in this standard.

Alternatively, where a fault of an internal component may lead to failure of encapsulation “m” due to increasing temperature, the requirements of 7.9 shall apply.

4.3 Additional requirements for level of protection “ma”

The working voltage at any point in the circuit shall not exceed 1 kV.

4.4 Rated voltage and prospective short circuit current

The rated voltage and the prospective short circuit current shall be specified such that the limiting temperature is not exceeded for the relevant level of protection “ma”, “mb” or “mc”.

5 Requirements for compounds

5.1 General

The documentation shall specify the compound(s) used and the processing method(s), including measures to prevent the formation of voids.

As a minimum, those properties of the compound(s) on which encapsulation “m” depends shall be provided.

NOTE Proper selection of the compound allows for the expansion of components during operation and in the event of allowable faults.

5.2 Specification

The specification for the compound shall include the following:

- a) the name and address of the manufacturer of the compound,
- b) the exact and complete reference of the compound and if relevant, percentage of fillers and any other additives, the mixture ratios and the type designation,
- c) if applicable, any treatment of the surface of the compound(s), for example varnishing,
- d) if applicable, to obtain correct adhesion of the compound to a component, any requirement for pre-treating of the component for example cleaning, etching,
- e) the dielectric strength in accordance with IEC 60243-1 at the maximum service temperature of the compound determined according to 8.2.2 a) if available; if not available, the requirements of 5.3.2 shall be applied,
- f) temperature range of the compound(s) (including maximum continuous operating temperature (COT) and minimum continuous operating temperature (COT)),

g) in the case of “m” equipment where the compound is part of the external enclosure, the temperature index TI value as defined by IEC 60079-0. As an alternative to the TI, the relative thermal index (RTI-mechanical) may be determined in accordance with ANSI/UL 746B,

h) the colour of the compound used for the test samples, where the compound specification will be influenced by changing the colour,

i) Thermal conductivity if utilizing the alternative test method in 6.2.2.

NOTE It is not a requirement of this standard that conformity to the manufacturer’s specification of the compound needs to be verified.

5.3 Properties of the compound

5.3.1 Water absorption

5.3.1DV DR *Modification of Clause 5.3.1 to replace with the following:*

Either the compound shall be tested in accordance with 8.1.1 or, if this test is not performed, the certificate number for the equipment shall include the “X” suffix be marked to indicate the specific conditions of use in accordance with the “specific conditions of use” marking requirements of IEC UL 60079-0 and the specific conditions of use listed on the certificate shall detail the precautions necessary.

5.3.2 Dielectric strength

Where the dielectric strength according to IEC 60243-1 at the maximum service temperature according to 8.2.2 a), of the compound is not available from the material manufacturer, a test shall be performed in accordance with 8.1.2.

NOTE It is not a requirement of this standard that conformity to the manufacturer’s specification of the compound needs to be verified.

6 Temperatures

6.1 General

The service temperature of the compound, determined in accordance with IEC 60079-0, shall not exceed the maximum value of the COT of the compound. The maximum surface temperature shall be determined in accordance with IEC 60079-0 under normal operation and under fault conditions as defined in 7.2.1. The “m” equipment shall be protected in such a way that the encapsulation “m” is not adversely affected under these fault conditions.

6.2 Determination of the limiting temperature

6.2.1 Maximum surface temperature

The maximum surface temperature shall be determined using the test method given in 8.2.2 in accordance with the supply conditions specified in 4.4.

NOTE This temperature is used to determine either the temperature class for explosive gas atmospheres or the maximum surface temperature in degree Celsius for explosive dust atmospheres of the equipment, or both.

6.2.2 Temperature of the compound

The hottest component shall be determined. The maximum temperature in the compound, adjacent to the hottest component, shall be determined using the test method given in 8.2.2 for normal operation.

As an alternative the determination of the temperature of the hottest component in normal operation may be done by calculation, manufacturer's specification or by testing the component under intended application conditions prior to encapsulating the component if the thermal conductivity of the compound is greater than that of air.

NOTE Thermal conductivity of air is most often defined as 0.25 W/m*K (standard conditions).

6.3 Temperature limitation

Where the equipment may be subject to fault in accordance with 7.2.1, or where there is the possibility of an increased temperature, for example by an unfavourable input voltage in accordance with 7.2.1 or an unfavourable load, this shall be taken into account in determining the limiting temperatures.

When a protective device is required to limit temperatures for safety reasons, it shall be an electrical or thermal device external to the equipment or directly integrated into the equipment, as defined in 7.9.

7 Constructional requirements

7.1 General

7.1DV DR Modification of Clause 7.1 to replace with the following:

Where the compound forms part of the external enclosure it shall comply with the requirements of IEC UL 60079-0 for non metallic enclosures and non metallic parts of enclosures.

If the surface of the compound is totally or partly surrounded by an enclosure and the enclosure is part of the protection, the enclosure or parts of the enclosure shall comply with the enclosure requirements of IEC UL 60079-0

Additional protective measures may be required to be provided by the user in the installation in order to comply with the requirements of this standard. For example, additional mechanical protection may be required to protect the equipment from a direct impact. In such cases, the certificate number for the equipment shall be marked include the "X" suffix in accordance with the marking requirements of IEC UL 60079-0 and the specific conditions of use listed in the certificate shall detail the precautions necessary.

Appropriate action shall be taken to accommodate the expansion of components during normal operation and in the event of faults according to 7.2.

In 7.2 to 7.9 the requirements differ according to whether the compound adheres to the enclosure. Where adhesion is specified, the aim is to prevent the ingress of explosive atmospheres and moisture at the boundary surfaces (for example enclosure-compound, compound-parts that are not completely embedded in the compound, such as printed wiring boards, connection terminals, etc.). Where adhesion is required to maintain the type of protection, it shall be maintained after completion of all the prescribed tests. The choice of the compound(s) to be used for a specific application is dependent on the task each compound has to perform. Testing a compound once for a given application will not qualify that compound for all applications.

NOTE Tests for adhesion are under consideration.

7.2 Determination of faults

7.2.1 Fault examination

When tested in accordance with IEC 60079-0, encapsulation “m” shall be maintained in the case of

- a) the most unfavorable output load and
- b) up to two internal countable faults for level of protection “ma”, and up to one internal countable fault for level of protection “mb”, taking into account 7.2.2, 7.2.3 and 7.2.4.

No faults are taken into account for level of protection “mc”.

NOTE Examples of faults are: a short circuit in any component, the failure of any component and a fault between tracks in the printed wiring board, but not the opening of a track.

The failure of some components may result in an unstable condition, for example, alternating between high and low resistance. In those cases, the most onerous condition shall be considered.

If a fault leads to one or more subsequent faults, for example, due to the overload of a component, the primary and subsequent fault(s) shall be considered to be a single fault.

7.2.2 Components considered as not subject to fail

For levels of protection “ma” and “mb” the following components shall be considered as not to fail if they are encapsulated according to the requirements of this standard, if they are suitable for the service temperature and if they are not operated at more than 2/3 of their rated voltage, rated current or rated power related to the rating of the device, the mounting conditions and the temperature range specified:

- resistors,
- single-layer, spirally wound coils,
- plastic foil capacitors,
- paper capacitors,
- ceramic capacitors,
- semiconductors,
- semiconductor devices used as a protective device according to 7.9,
- resistors used as a protective device according to 7.9, if they comply with the current limiting resistors of IEC 60079-11 for level of protection “ia” or “ib”.

For levels of protection “ma” and “mb” windings that comply with IEC 60079-7, including also those that have wire diameters of less than 0,25 mm shall be considered as not subject to failure if they are encapsulated according to the requirements of this standard.

7.2.3 Isolating components

The following components for the segregation of different circuits shall be considered to provide isolation and are not considered to fail across the segregation:

- Galvanically separating components (e.g. optocouplers and relays),
 - if the rated insulation voltage conforms to $2U + 1\,000\text{ V r.m.s. }^{+5}_0\%$ or $1\,500\text{ V r.m.s.}$ whichever is greater (U is the sum of the rated r.m.s. voltages of both circuits), or
 - for a rated insulation voltage across the segregation of more than 60 V (sum of the rated r.m.s. voltages of both circuits), optocouplers and relays providing a double or reinforced insulation between the circuits per IEC 61140, or
 - complying with IEC 60079-11 for level of protection “ia” or “ib”.
- Transformers,
 - complying with IEC 61558-2-6, or
 - providing a double or reinforced insulation between the circuit per IEC 61558-1, or
 - complying with IEC 60079-11 for level of protection “ia” or “ib”.

NOTE 1 It is not a requirement of this standard that conformity to the above standards per the manufacturer's specification regarding segregation needs to be verified.

NOTE 2 Galvanically separating components providing double or reinforced insulation according to a product standard are considered to meet the requirements of IEC 61140 e.g. IEC 60747-5-5 for optocouplers.

7.2.4 Infallible separation distances

7.2.4.1 General

It is not necessary to consider the possibility of a fault occurring as described in 7.2.1 in respect of voltage breakdown, if the distances between bare current-carrying parts:

- of the same circuit, or
- of a circuit and earthed metal parts, or
- of two separate circuits (sum of the working voltages shall be taken as the voltage for Table 1; where one of the working voltages is less than 20 % of the other, it shall be ignored),

comply with the requirements of 7.2.4.2 and if applicable 7.2.4.3.

7.2.4.2 Distances through the compound

Distances through compound shall be considered to be infallible against short circuit for level of protection "ma" and level of protection "mb" if they comply with the values in Table 1, provided that the distances in the compound are fixed or secured mechanically before encapsulation.

NOTE When a suitably adhered non-metallic enclosure of a given specific minimum thickness permits a zero thickness of compound per Key letter c of Table 4 and Figure 1, then the separation distances for the associated current carrying parts are still considered infallible against short circuit.

Distances between the minimum distances given for level of protection "mc" and the infallible distances given for level of protection "ma" and "mb" are not considered infallible and shall be assessed as a "countable fault". Distances less than those given for level of protection "mc" are considered as short-circuits if this impairs the type of protection "m".

For level of protection "mc" the values of Table 1 are the constructional requirements and may be achieved by mechanically fixing before encapsulation.

Table 1 – Distances through the compound

Voltage U r.m.s. or d.c. (see ^a) V	Minimum distance mm		
	“ma”	“mb”	“mc”
≤ 32	0,5	0,5	0,2
≤ 63	0,5	0,5	0,3
≤ 400	1	1	0,6
≤ 500	1,5	1,5	0,8
≤ 630	2	2	0,9
≤ 1 000	2,5	2,5	1,7
≤ 1 600	–	4	4
≤ 3 200	–	7	7
≤ 6 300	–	12	12
≤ 10 000	–	20	20

^a Voltages shown are derived from IEC 60664-1 and are based on the rationalization of supply voltages given in Table 3b of IEC 60664-1. When determining the required distance, the working voltage may be higher than the voltage in the table by a factor of 1,1.

NOTE The factor 1,1 recognizes that at many places in a circuit, the working voltage equals the rated voltage and that there are a number of rated voltages in common use that can be accommodated by the 1,1 factor.

7.2.4.3 Distances through solid insulation

The distance through solid insulation, on which the type of protection “m” depends, shall be at least 0,1 mm and shall comply with the dielectric strength test of 8.2.4.

7.3 Free space in the encapsulation

7.3.1 Group III “m” equipment

The sum of the free spaces is not limited, but the volume of each individual free space is limited to 100 cm³. The thickness of the compound surrounding such free spaces shall meet the requirements of Table 2.

Table 2 – Minimum thickness of compound adjacent to free space for Group III “m” equipment

Level of protection	Minimum thickness of compound adjacent to free space to:	Free space ≤ 1 cm ³	Free space > 1 cm ³ ≤ 100 cm ³
“ma”	Free space or free surface	3 mm	3 mm
	Non-metallic or metal enclosure with adhesion	3 mm (enclosure + compound) ^a	3 mm (enclosure + compound) ^a
	Non-metallic or metal enclosure without adhesion	3 mm	3 mm
“mb”	Free space or free surface	1 mm	3 mm
	Non-metallic or metal enclosure with adhesion	1 mm (enclosure + compound)	3 mm (enclosure + compound) ^a
	Non-metallic or metal enclosure without adhesion	1 mm	3 mm
“mc”	Free space or free surface	1 mm	1 mm
	Non-metallic or metal enclosure with adhesion	1 mm (enclosure + compound)	1 mm (enclosure + compound)
	Non-metallic or metal enclosure without adhesion	1 mm	1 mm

Table 2 – Minimum thickness of compound adjacent to free space for Group III “m” equipment
Continued

Level of protection	Minimum thickness of compound adjacent to free space to:	Free space $\leq 1 \text{ cm}^3$	Free space $> 1 \text{ cm}^3 \leq 100 \text{ cm}^3$
^a Wall thickness of the enclosure $\geq 1 \text{ mm}$.			
The thickness of the materials quoted in this table does not imply compliance with other mechanical tests required by IEC 60079-0.			
NOTE A metal enclosure with adhesion is permitted to have no compound thickness to a free space provided there are no live parts in the free space.			

7.3.2 Group I and Group II “m” equipment

The sum of the free spaces shall not exceed:

- 100 cm³ for level of protection “mb” and “mc”;
- 10 cm³ for level of protection “ma”.

The minimum thickness of the compound surrounding such free spaces shall comply with Table 3.

Table 3 – Minimum thickness of compound adjacent to free space for Group I and Group II “m” equipment

Level of protection	Minimum thickness of compound adjacent to free space to:	Free space $\leq 1 \text{ cm}^3$	Free space $> 1 \text{ cm}^3 \leq 10 \text{ cm}^3$	Free space $> 10 \text{ cm}^3 \leq 100 \text{ cm}^3$
“ma”	Free space or free surface	3 mm	3 mm (pressure test in accordance with 8.2.6)	Not permitted
	Non-metallic or metal enclosure with adhesion	3 mm (enclosure + compound) ^a	3 mm (enclosure + compound) (pressure test in accordance with 8.2.6)	Not permitted
	Non-metallic or metal enclosure without adhesion	3 mm	3 mm (pressure test in accordance with 8.2.6)	Not permitted
“mb”	Free space or free surface	1 mm	3 mm	3 mm (pressure test in accordance with 8.2.6)
	Non-metallic or metal enclosure with adhesion	1 mm (enclosure + compound)	3 mm (enclosure + compound) ^a	3 mm (enclosure + compound) ^a (pressure test in accordance with 8.2.6)
	Non-metallic or metal enclosure without adhesion	1 mm	3 mm	3 mm (pressure test in accordance with 8.2.6)
“mc”	Free space or free surface	1 mm	1 mm	3 mm
	Non-metallic or metal enclosure with adhesion	1 mm (enclosure + compound)	1 mm (enclosure + compound)	3 mm (enclosure + compound) See note
	Non-metallic or metal enclosure without adhesion	1 mm	1 mm	3 mm

Table 3 – Minimum thickness of compound adjacent to free space for Group I and Group II “m” equipment Continued on Next Page

Table 3 – Minimum thickness of compound adjacent to free space for Group I and Group II “m” equipment Continued

Level of protection	Minimum thickness of compound adjacent to free space to:	Free space $\leq 1 \text{ cm}^3$	Free space $> 1 \text{ cm}^3 \leq 10 \text{ cm}^3$	Free space $> 10 \text{ cm}^3 \leq 100 \text{ cm}^3$
^a Wall thickness of the enclosure $\geq 1 \text{ mm}$.				
The thickness of the materials quoted in this table does not imply compliance with other mechanical tests required by IEC 60079-0.				
NOTE A metal enclosure with adhesion is permitted to have no compound thickness to a free space provided there are no live parts in the free space.				

7.4 Thickness of the compound

7.4.1 “m” equipment

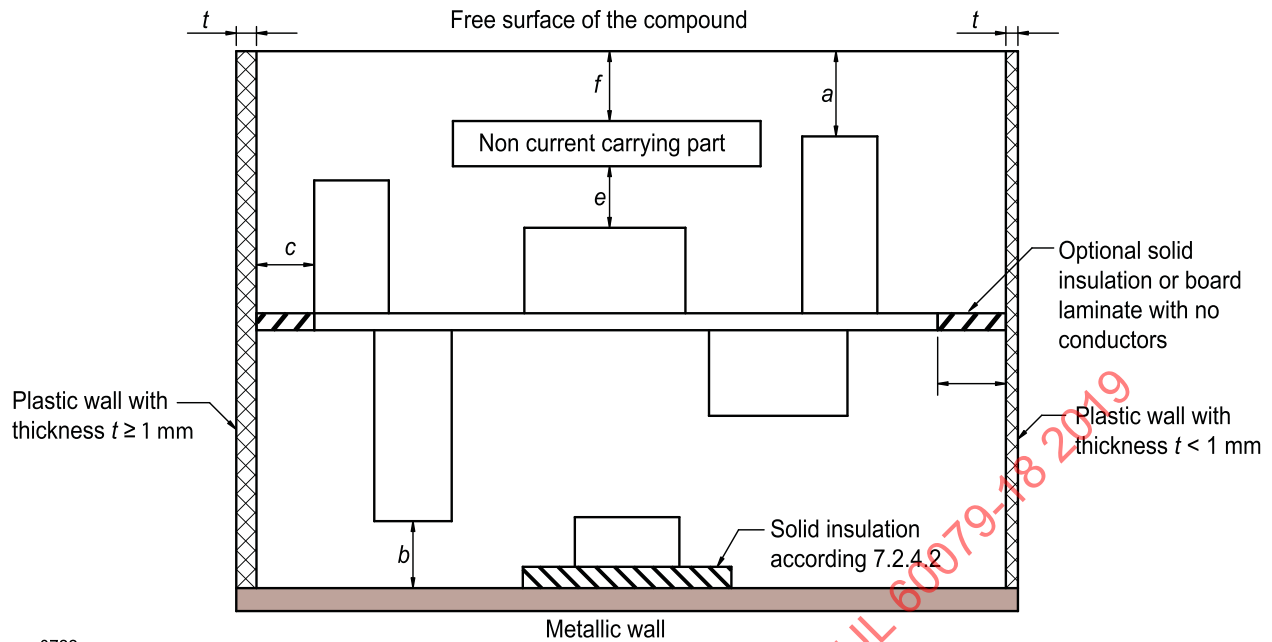
The minimum thickness of compound surrounding the electrical components and circuit shall be in accordance with Table 4 and Figure 1.

If solid insulation according to 7.2.4.3 is used in an enclosure with metallic walls as shown in Figure 1, the compound shall adhere to the wall.

NOTE 1 Figure 1 does not necessarily represent a practical construction, but is intended to assist in understanding Table 4 by showing an encapsulated circuit that includes a free surface; a metallic enclosure; a plastic enclosure with different wall thicknesses.

When a suitably adhered non-metallic enclosure of a given specific minimum thickness permits a zero thickness of compound per Key letter c of Table 4 and Figure 1, then the separation distances for the associated current carrying parts are still considered infallible against short circuit.

NOTE 2 Separation distances (creepages and clearances) associated with such current carrying parts that are permitted to have zero thickness of compound and still be considered infallible against short circuit, are evaluated in accordance with the applicable safety requirements of the relevant industrial standards.



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Key a distance to free surface b distance to metal enclosure c distance to non metallic enclosure with wall thickness $t \geq 1$ mm d distance to non metallic enclosure with wall thickness $t < 1$ mm e distance to non current carrying part within the compound f distance from non current carrying part to free surface**Figure 1 – Dimensional key for thickness through the compound**

In all cases the compound shall be subjected to the dielectric strength test of 8.2.4.

Table 4 – Thickness of the compound

	Level of protection “ma”	Level of protection “mb” or “mc”
Free surface $\leq 2 \text{ cm}^2$	$a \geq 3 \text{ mm}$	$a \geq \text{distance according to Table 1 but not less than } 1 \text{ mm}$
Free surface $> 2 \text{ cm}^2$	$a \geq 3 \text{ mm}$	$a \geq \text{distance according to Table 1 but not less than } 3 \text{ mm}$
non metallic enclosure with adhesion (wall thickness $t < 1 \text{ mm}$)	$d \geq 3 \text{ mm}$	$d \geq \text{distance according to Table 1 but not less than } 1 \text{ mm}$
non metallic enclosure with adhesion (wall thickness $t \geq 1 \text{ mm}$)	$c \geq (3 \text{ mm} - t)^a$	$c \geq (\text{distance according to Table 1} - t)^a$
Non metallic enclosure without adhesion	$c = d \geq 3 \text{ mm}$	$c = d \geq \text{distance according to Table 1 but not less than } 1 \text{ mm}$
Metal enclosure	$b \geq 3 \text{ mm}$	$b \geq \text{distance according to Table 1 but not less than } 1 \text{ mm}$
Non current carrying part	$e \geq 3 \text{ mm}$	$e \geq \text{distance according to Table 1 but not less than } 1 \text{ mm}$
Non current carrying part – free surface	$f + e \geq a$	$f + e \geq a$
^a In the case of non metallic enclosure with adhesion and wall thickness $\geq 1 \text{ mm}$ if the application of the formula allows $c = 0$ the component may be placed against the wall.		

7.4.2 Windings for electrical machines

For electrical machines with windings in slots, the solid slot insulation shall have:

- for level of protection “ma” only, a minimum thickness of 0,1 mm and shall be extended by at least 5 mm beyond the end of the slot;
- for levels of protection “ma” and “mb”, the end of the slot and the end-winding shall be protected by the minimum thickness of compound in accordance with 7.4.1. A dielectric strength test in accordance with 8.2.4, shall be passed with a test voltage $U = 2U + 1\,000 \text{ V r.m.s.}^{+5}_0\%$ with a minimum of 1 500 V a.c. at 48 Hz to 62 Hz.

Varnish and similar coatings are not considered to be solid insulation.

7.4.3 Rigid, multi-layer printed wiring boards with through connections

7.4.3.1 General

Multi-layer printed wiring boards complying with the requirements of IEC 62326-4-1, performance level C, or IPC-A-600 and IPC-6012 or ANSI/UL 796, operated at working voltages less than or equal to 500 V, shall be considered to be encapsulated providing they meet 7.4.3.2

NOTE It is not a requirement of this standard that conformity to the manufacturer's performance specification of the printed wiring board needs to be verified

7.4.3.2 Minimum distances

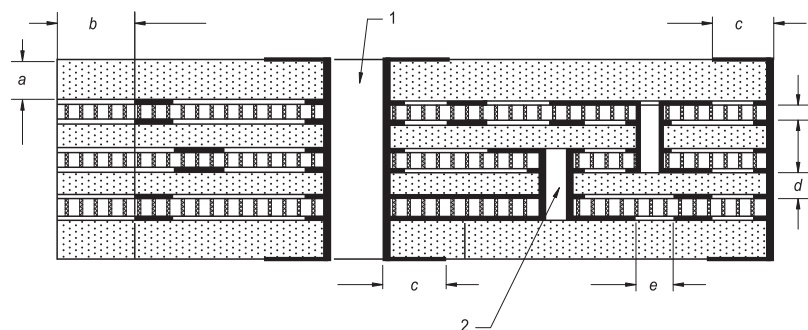
The insulation thickness of both, the copper-clad laminates and the adhesive films shall comply with the requirements of 7.2.4.3.

NOTE The insulation thickness is the combination of the laminate and the adhesive film when they are not separated by copper.

The minimum distance between the printed circuit conductors and the edge of the multi-layer printed wiring board or any hole in it shall be at least distance *b* of Table 5. If the edges or holes are protected with metal or insulating material extending at least 1 mm along the surface of the board from the edges or holes, the distance between the printed wiring conductors and the metal or insulating material may be reduced to distance *c* of Table 5. Metal coating shall have a minimum thickness of 35 µm, (see also Figure 2 and Table 5).

Table 5 – Minimum distances for multi-layer printed wiring boards

Distance	Level of protection "ma"	Level of protection "mb"	Level of protection "mc"
<i>a</i>	3 mm	0,5 mm	0,25 mm
<i>b</i>	3 mm	3 mm	1 mm
<i>c</i>	3 mm	1 mm	0,5 mm
<i>d</i>	0,1 mm, see 7.2.4.3	0,1 mm, see 7.2.4.3	0,1 mm, see 7.2.4.3
<i>e</i>	In accordance with Table 1	In accordance with Table 1	In accordance with Table 1
where <i>a</i> is the distance between the current carrying part and the outside surface through the cover layer; <i>b</i> is the distance between the current carrying part and the outside surface along the cover layer; <i>c</i> is the length of metal or insulation extending along the surface of the board from the edge or the hole; <i>d</i> is the thickness of the adhesive film or the core where segregation is required; <i>e</i> is the distance between two circuits inside the multilayer where segregation is required.			



- Key
- Core and cover layer
- Adhesive filmcopper
- Copper
- 1 Through contact for termination
- 2 Through contact to connect the printed conductors to the layers

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Figure 2 – Minimum distances for multi-layer printed wiring boards

7.5 Switching contacts

7.5.1 General

Switching contacts shall be provided with an additional enclosure.

NOTE Entering of compound in the enclosure of the switching contacts during the encapsulation process can interfere with the function of the device

7.5.2 Level of protection “ma”

This additional enclosure shall be in accordance with the requirements for hermetically-sealed devices as defined in IEC 60079-15 before encapsulation.

NOTE Damage to the hermetically-sealed enclosure due to stresses during potting can invalidate the type of protection of the device.

The rating of the switching contacts shall be less than or equal to 60 V and 6 A. The additional enclosure shall be made of inorganic material if the switched current exceeds 2/3 of the rated current specified by the manufacturer of the component.

7.5.3 Level of protection “mb”

This additional enclosure shall be made of inorganic material if the switched current exceeds 2/3 of the rated current specified by the manufacturer of the component or if the current exceeds 6 A.

7.5.4 Level of protection “mc”

This additional enclosure shall be made of inorganic material if the switched current exceeds 6 A.

7.6 External connections

7.6.1 General

When compounds are used to secure a permanently connected cable, the cable shall be suitably protected against damage from flexing and the pull test shall be carried out according to 8.2.5.

This test shall not be performed on Ex Components or where the enclosure of the “m” protected device does not serve as an external enclosure.

7.6.2 Additional requirements for “ma” equipment

7.6.2DV DR Modification of Clause 7.6.2 to replace with the following:

The Ex ma equipment shall either be supplied by a circuit in accordance with level of protection “ia” according to IEC UL 60079-11 or have a connection in accordance with one of the following requirements:

- for EPL Ga requirements of IEC 60079-26;
- for EPL Da, level of protection “ta” of IEC UL 60079-31.

7.7 Protection of bare live parts

Depending on the required EPL bare live parts that pass through the surface of the compound shall be protected by another type of protection as listed in IEC 60079-0 for the required EPL.

NOTE In this case, the equipment is marked with multiple types of protection in accordance with IEC 60079-0

7.8 Cells and batteries

7.8.1 General

When evaluating battery control arrangements with respect to the potential release of gas, the full range of operating temperatures, internal resistance and voltage capability shall be considered. It shall be assumed that batteries can become unbalanced, but cells with negligible resistance or voltage capability need not be taken into account.

Subclause 7.8 applies to all levels of protection, unless specifically excluded.

For level of protection “ma” cells and batteries shall additionally comply with the cell and battery requirements of IEC 60079-11 except for the relaxation for parallel cells, which are not permitted in equipment solely protected by encapsulation.

7.8.2 Prevention of gassing

Electrochemical systems that can release gas during normal operation are not permitted. If for levels of protection “ma” and “mb” the release of gas in the event of a fault cannot be precluded, the gassing shall be minimised by a control device in accordance with 7.8.8. With secondary cells, the control device shall be effective not only during charging, but also during discharging. This also applies for charging outside the hazardous area.

In particular,

- a) vented cells shall not be used,
- b) sealed valve regulated cells shall not be used,
- c) sealed gas-tight cells that, within the range of the ambient temperature of the electric equipment, do not release gas under any operating or fault conditions may be used without a control device in accordance with 7.8.8.

Gas-tight cells that do not fulfil the requirements of 7.8.2 c) shall have a control device in accordance with 7.8.8.

7.8.3 Protection against inadmissible temperatures and damage to the cells or batteries

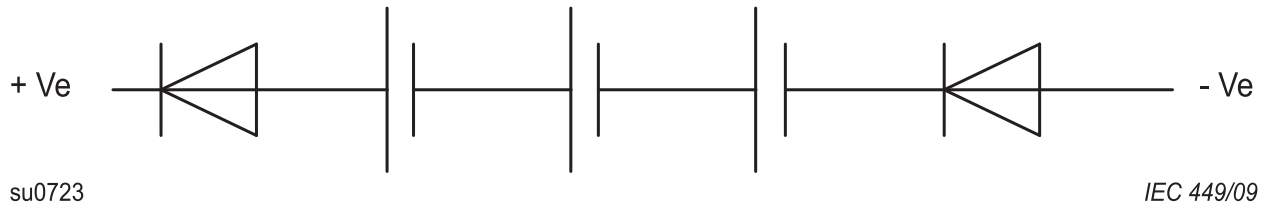
The maximum service temperature of the cells or batteries under worst case load (see 7.8.5) shall not exceed either the temperature specified by the manufacturer of the cells or batteries, or 80 °C if not specified by the manufacturer and the maximum charging and discharging current shall not exceed the safe value specified by the manufacturer by one of the following means:

- a) shall be provided with one or more control devices as described in 7.8.8 to prevent unacceptable overheating or gassing inside the compound,
- b) shall be provided with a series resistor to limit current to the cell rating and a blocking diode to preclude reverse charging.

In either case, the requirements in 7.8.4 through 7.8.7 apply as applicable.

7.8.4 Reverse current

For levels of protection “ma” and “mb” where there is another voltage source in the same enclosure, the encapsulated cell or battery and its associated circuits shall be protected against charging by circuits other than those specifically designed for charging. For example, by separating the cell or battery and its associated circuits from all other voltage source(s) inside the enclosure, using the distances specified in Table 1 for the highest voltage capable of causing the reverse current. Alternatively, the cell or battery only may be separated, from the other voltage source(s) using the distances specified in Table 1, but with one blocking diode for level of protection “mb”, or two blocking diodes for level of protection “ma”, fitted as shown in Figure 3, and so arranged as to reduce the risk of a single fault causing both diodes to be short-circuited.



NOTE Figure shows arrangement for Level of Protection “ma”.

Figure 3 – Fitting of blocking diodes

7.8.5 Current limitation

7.8.5DV DR Modification of Clause 7.8.5 to replace with the following:

The maximum surface temperature shall be determined using the highest discharge current permitted by the maximum load specified by the equipment manufacturer, or by the protective device, see 7.9, for example 1,7 times the rating of the fuse, or at short circuit if neither a load nor a protective device is specified.

A resistor, a current limiting device or a fuse according to IEC 60127 or IEC UL 60691 or ANSI/UL 248 series may be used to ensure the maximum discharge current specified by the manufacturer of the cells or battery is not exceeded. If replaceable fuses are used the equipment shall be marked to show their rating and function.

NOTE It is not a requirement of this standard that conformity to the manufacturer's specification of the resistor, current limiting device or fuse needs to be verified.

7.8.6 Protection against the polarity inversion and deep discharge of the cells

For level of protection “ma” and “mb” when more than 3 cells are used in series, the cell voltage shall be monitored. During discharging, if the voltage falls below the limit value for the cell voltage specified by the manufacturer of the cells or battery, the control device shall disconnect the cells or battery. For level of protection “mc”, if more than three cells are connected in series, precautions shall be taken to prevent reverse polarity charging of the cell.

NOTE 1 If several cells are connected in series, cells can change polarity during discharge due to the various capacities of the cells in a battery. These “reversed pole” cells can enter an inadmissible gassing range.

Where a deep discharge protection circuit is used to prevent reverse polarity charging of cells during discharge, the minimum cut-off voltage shall be that specified by the cell or battery manufacturer. After disconnecting the load, the current shall be no more than the discharge capacity at the 1 000 h rate.

NOTE 2 Such protection is often used to prevent cells going into a state of “deep discharge”. If an attempt is made to monitor too many cells connected in series, the protection will sometimes not function reliably due to tolerances in individual cell voltages and the protection circuit. Generally, monitoring of more than six cells (in series) by one protection unit is not effective.

7.8.7 Charging of cells or batteries

7.8.7.1 Level of protection “ma” and “mb”

The charging circuits shall be fully specified as part of the equipment. The charging system shall be such that either:

a) with one fault condition of the charging system, the charging voltage and current shall not exceed the limits specified by the manufacturer;

or

b) if, during charging, it is possible for the limit values specified by the manufacturer of the cells or battery for the cell voltage or the charging current to be exceeded, a separate protective device in accordance with 7.9 shall be provided to minimize the possibility of a release of gas and also exceeding the manufacturer’s maximum rated cell temperature during charging.

7.8.7.2 Level of protection “mc”

The charging system shall be such that in normal operation the charge voltage and current do not exceed the limits specified by the manufacturer based on the specified temperature range of the equipment. If cells and batteries, which are an integral part of the electrical equipment are to be charged in the hazardous area, the charger shall be fully specified as part of the equipment design. If cells or batteries, which are an integral part of the electrical equipment or can be separated from the equipment are charged outside of the hazardous area, the charging shall be within the limits specified by the manufacturer of the equipment.

7.8.8 Requirements for control safety devices for cells or batteries

Where required, the control devices shall form safety related parts of a control system. It shall be the responsibility of the manufacturer to provide the information necessary to maintain the integrity of the system.

NOTE Safety related parts meeting the requirements of PL c of ISO 13849-1 “Safety of machinery – Safety related parts of control systems – Part 1: General principles for design” will satisfy this subclause.

7.9 Protective devices

7.9.1 General

If relying on a protective device to limit maximum surface temperature when the “m” equipment is subjected to a single fault for level of protection “mb” or two faults for level of protection “ma” the protective device shall be provided either external to the equipment or directly integrated into the equipment. Protective devices for level of protection “ma” shall be non resettable. Thermal protective devices for level of protection “mb” may be resettable.

The protective device shall be capable of interrupting the maximum fault current of the circuit in which it is installed. The rated voltage of the protective device shall at least correspond to the working voltage of the circuit in which it is installed.

Where the “m” equipment contains a cell or battery and a control device is provided to prevent excessive overheating (see 7.8.5), this control device can also be considered as a protective device, providing it also protects all other components inside the same compound from exceeding the maximum surface temperature.

NOTE 1 The use of protective devices is to protect against faults and unforeseen overloads, which overheat and/or permanently damage or compromise the operational life of the equipment. Where resettable devices are used, the instructions include information to guide the user in the desirability of re-setting the devices. These instructions are considering external operational conditions under which they might be reset and also any subsequent monitoring that might be desirable.

NOTE 2 Both, self-resetting and manually resettable devices are considered to be resettable devices for the purpose of this standard.

7.9.1DV.1 DR Modification of Clause 7.9.1, fourth paragraph, Note 3 and Note 4 to replace with the following:

7.9.1DV.1.1 For level of protection “ma”, if the non resettable protective device complies with IEC 60127 series or IEC UL 60691 or ANSI/UL 248 series, only one device is necessary. This applies to 7.9.2 and 7.9.3.

NOTE 3 It is not a requirement of this standard that conformity to the manufacturer's specification of the non resettable protective device needs to be verified.

NOTE 4 ANSI/UL 248-1 contains the applicable general safety requirements for low-voltage fuses, including the requirements to establish breaking capacity or interrupting rating. The other parts of the ANSI/UL 248 series provide additional specific safety requirements based on the intended application of the fuse, such as ANSI/UL 248-14 for supplemental low-voltage fuses.

7.9.2 Electrical protective devices

7.9.2.1 General

Protective devices shall have a voltage rating not less than that of the circuit in which they are installed and shall have a breaking capacity not less than the fault current of the circuit.

Unless otherwise specified, a fuse shall be assumed to be capable of passing 1,7 times the rated current continuously. The time-current characteristic of the fuse, as stated by the manufacturer of the fuse, shall ensure that the maximum surface temperature is not exceeded. For electrical protective devices two devices normally in series are required for level of protection "ma" and one device is required for level of protection "mb". If for level of protection "ma", the two devices are not in series, the activation of either device shall de-energize the circuitry relying on the protection. The two devices for level of protection "ma" shall be the same type of protective device (while not necessarily the same manufacturer and part number), so as to provide duplicated protection.

An electrical protective device is not required for level of protection "mc".

NOTE In the case of electrical supply networks where the rated voltage does not exceed 250 V, the prospective short-circuit fault current is usually 1 500 A.

7.9.2.2 Protective devices that are connected to the "m" equipment

If the protective device is external to the "m" equipment it shall be seen as equipment required for the safety of the "m" equipment, in accordance with 7.9.2. This specific condition of use shall appear on the certificate and the equipment shall be marked in accordance with the "specific conditions of use" marking requirements of IEC 60079-0.

The use of an external protective device and its connection to "m" equipment requires the device to be compatible with "ma", "mb", or "mc" as appropriate.

NOTE Failure to use such a device in the intended manner will lead to loss of level of protection. Where an external protective device is used to control the correct application of voltage, current and power to equipment with level of protection "ma", the performance of the external protective device or protective circuit is safe with one countable fault. The permitted levels of voltage, current and power are determined by the thermal characteristics of the "m" equipment.

7.9.3 Thermal protective devices

Thermal protective devices shall be used to protect the compound from damage caused by local heating, for example, by faulty components, or from exceeding the maximum surface temperature.

Non-resettable devices have no provision for being reset and open a circuit permanently after being exposed to a temperature higher than their operating temperature for a given maximum period. Adequate thermal coupling shall be achieved between the monitored component and the thermal protective device. The switching capability of the device shall be defined and shall be not less than the maximum possible load of the circuit.

If resettable thermal protective devices are used, two devices normally in series are required for level of protection “mb” and one device is required for level of protection “mc”. If for level of protection “mb” the two resettable thermal protective devices are not in series, the activation of either device shall de-energize the circuitry relying on the protection. The two devices for level of protection “mb” shall be the same type of thermal protective device (while not necessarily the same manufacturer and part number), so as to provide duplicated protection.

Resettable thermal protective devices with switching contacts shall not be operated at more than 2/3 of their rated current specified by the manufacturer of the device.

7.9.3DV.1 DR Modification of Clause 7.9.3, fifth paragraph to replace with the following:

7.9.3DV.1.1 Resettable thermal protective devices with switching contacts shall either comply with IEC UL 60730-2-9, or shall be tested according to 8.2.7.1

Resettable thermal protective devices without switching contacts shall either comply with IEC 60738-1, or shall be tested according to 8.2.7.2

NOTE 1 Often for functional reasons, additional resettable devices other than the thermal protective devices addressed by this clause are used. These devices typically operate at temperatures lower than the operating temperature of the thermal protective device.

NOTE 2 It is not a requirement of this standard that conformity to the manufacturer's specification of the resettable thermal protective device needs to be verified.

7.9.4 Built-in protective devices

Protective devices integral with the “m” equipment shall be of the enclosed type such that no compound can enter during the encapsulation process.

The suitability of the protective device for encapsulation shall be confirmed either by:

a) a documentation from the manufacturer of the device;

or

b) testing of samples according 8.2.8

NOTE Devices in glass, plastic, ceramic or otherwise sealed are regarded as enclosed types.

8 Type tests

8.1 Tests on the compound

8.1.1 Water absorption test

When required by 5.3.1 the test shall be carried out on samples of the compound(s) used in “m” equipment. Three dry samples of the compound(s) shall be tested. The samples shall be circular with a diameter of $50 \text{ mm} \pm 1 \text{ mm}$ and a thickness of $3 \text{ mm} \pm 0,2 \text{ mm}$. The samples shall be weighed then immersed for at least 24 h in water, at a temperature of $23 \text{ }^{\circ}\text{C} +2_0 \text{ K}$. They shall then be taken out of the water, wiped dry and weighed again within 1 minute. The increase in mass shall not exceed 1 %.

It is not required to use distilled water for this test.

8.1.2 Dielectric strength test

The sample shall be circular with a diameter of $50 \text{ mm} \pm 1 \text{ mm}$ and a thickness of $3 \text{ mm} \pm 0,2 \text{ mm}$. The sample shall be symmetrically placed between electrodes $30 \text{ mm} \pm 1 \text{ mm}$ in diameter, within a temperature controlled oven, set to achieve the maximum service temperature of the compound.

A voltage of 4 kV r.m.s. $+5_0 \%$ and with frequency between 48 Hz and 62 Hz shall be applied for not less than 5 min. No flashover or breakdown shall occur during the test.

8.2 Tests on the apparatus

8.2.1 Test sequence

The test sequence and number of samples are given in Annex B.

8.2.2 Maximum temperature

8.2.2DV DR Modification of Clause 8.2.2 to replace with the following:

A sample of “m” equipment shall be subjected to a type test to ensure that:

- a) the temperature limits specified in 6.1 are not exceeded in normal operation;**
- b) for level of protection “ma” and “mb” the maximum surface temperature is not exceeded under fault conditions as defined in 7.2.1.**

For “m” equipment without an external load, the test shall be carried out in accordance with the temperature measurements of IEC UL 60079-0 taking into account the supply conditions given in 4.4.

For “m” equipment with an external load, the test shall be carried out for level of protection “ma” and “mb” by adjusting the current to the highest value, which does not cause the protective device to operate, and for level of protection “mc” at the specified load parameters in normal operation and in the case of regular expected occurrences.

For level of protection “ma” equipment, designed for EPL “Da” the maximum surface temperature shall be determined with the equipment mounted in accordance with the manufacturer’s instructions, and surrounded on all available surfaces by dust with a layer thickness of at least 200 mm. The final temperature shall be considered to have been reached when the rate of rise of temperature does not exceed 1 K/24 h.

For EPL “Db”, the maximum surface temperature shall be determined with the equipment mounted in accordance with the manufacturer’s instructions with the additional requirement that the apparatus shall be covered with the maximum amount of dust that it can retain.

The measurement for the maximum surface temperature shall be determined using a test dust having a thermal conductivity of no more than 0,10 W/(m.K) measured at (100 ± 5) °C, or grain dust consisting of wheat or corn dust, or both, that has passed through a USA Standard 150 Micron (100 mesh) wire cloth per ASTM-E11.

NOTE 1 Testing, simulation and analysis is sometimes used in order to achieve the required temperature limitations under malfunction conditions for equipment with characteristics such as non-linear external loads, input power control, or difficult to define failure modes.

NOTE 2 The IEC 60079 series only permits use of a test dust having a thermal conductivity of no more than 0,10 W/(m.K) measured at (100 ± 5) °C.

8.2.3 Thermal endurance test

8.2.3.1 Thermal endurance to heat

8.2.3.1.1 Level of protection “ma” and “mb”

The test shall be carried out in accordance with IEC 60079-0. The temperature to be used as the reference service temperature for the test shall be either:

a) the maximum surface temperature of the test sample under normal operation plus 20 K;

or

b) the maximum temperature at the component surface in the compound under normal operation, see 6.2.2.

8.2.3.1.2 Level of protection “mc”

The test shall be carried out in accordance with IEC 60079-0.

The temperature to be used as the reference service temperature for the test shall be the maximum surface temperature under normal operation, see 6.2.1.

8.2.3.2 Thermal endurance to cold

The test shall be carried out in accordance with IEC 60079-0.

8.2.3.3 Acceptance criteria

After each test the sample shall be subjected to a visual inspection. No visible damage to the compound that could impair the type of protection shall be evident, for example cracks in the compound, exposure of encapsulated parts, failure of adhesion, inadmissible shrinkage, discoloration, swelling, decomposition or softening. A discoloration on the surface of the compound is permissible (for example oxidation in the case of epoxy resin).

In addition, any electrical protective device on which safety depends, other than thermal fuses, shall be verified as remaining functional.

8.2.4 Dielectric strength test

8.2.4.1 Test procedure

The test shall be carried out on the following arrangements of circuits as applicable:

- a) between galvanically isolated circuits;
- b) between each circuit and all earthed parts;
- c) between each circuit and the surface of the compound or the non-metallic enclosure that, if necessary, can be clad with a conductive foil.

For arrangement a), the voltage U to be used shall be the sum of the rated voltages of the two circuits being tested and for arrangements b) and c), the voltage U to be used shall be the rated voltage of the circuit being tested.

For arrangement b), circuits that contain transient suppression components connected between the circuit and the earthed parts, a special test sample without these components shall be permitted for the type test.

Dielectric strength shall be verified by test:

- either as given in a relevant industrial standard for the individual items of electrical equipment or,
- at the test voltage according to 1) or 2) below, and increased steadily within a period of not less than 10 s until it reaches the prescribed value, and it shall then be maintained for at least 60 s without dielectric breakdown occurring,

1) For equipment where the voltage U does not exceed 90 V peak, the test voltage shall be 500 V r.m.s. (+5₀ %) at 48 Hz to 62 Hz. Alternatively, the test voltage shall be 700 V d.c. (+5₀ %)

2) For equipment where the voltage U exceeds 90 V peak, the test voltage shall be $2U + 1\,000$ V r.m.s. (+5₀ %), with a minimum of 1 500 V r.m.s. at 48 Hz to 62 Hz. Alternatively, the test voltage shall be $2U + 1\,400$ V d.c. (+5₀ %) with a minimum of 2 100 V d.c.

The test voltage shall be increased steadily within a period of not less than 10 s until it reaches the prescribed value, and it shall then be maintained for at least 60 s.

NOTE 1 In the case of equipment that, for electro-magnetic compatibility reasons, contain components connected to the enclosure for the suppression of interference pulses and which could be damaged during the tests, a partial discharge test is sometimes used as an alternative.

NOTE 2 If the circuit under test is not accessible from the exterior it is possible to prepare a specific test sample with additional connections